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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



ALPHA & OMEGA
SEMICONDUCTOR



AOT430 N-Channel Enhancement Mode Field Effect Transistor

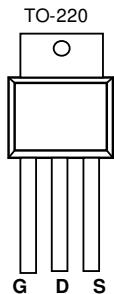
General Description

The AOT430 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications. *Standard Product AOT430 is Pb-free (meets ROHS & Sony 259 specifications).*

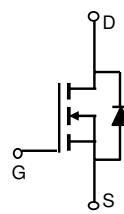
Features

$V_{DS} (V) = 75V$
 $I_D = 80 A$ ($V_{GS} = 10V$)
 $R_{DS(ON)} < 11.5m\Omega$ ($V_{GS} = 10V$)

UIS TESTED!



Top View
Drain Connected
to Tab



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	75	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current ^A	I_D	80	A
$T_C=100^\circ C$		78	
Pulsed Drain Current ^C	I_{DM}	200	
Avalanche Current ^C	I_{AR}	45	A
Repetitive avalanche energy $L=0.3mH$ ^C	E_{AR}	300	mJ
Power Dissipation ^B	P_D	268	W
$T_C=25^\circ C$		134	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	Steady-State	$R_{\theta JA}$	45	°C/W
Maximum Junction-to-Case ^B	Steady-State	$R_{\theta JC}$	0.45	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{\text{GS}}=0\text{V}$	75			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$		1		μA
			$T_J=55^\circ\text{C}$		5	
I_{GSS}	Gate-Body leakage current	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 25\text{V}$			1	μA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	2	2.7	4	V
$I_{\text{D}(\text{ON})}$	On state drain current	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=5\text{V}$	200			A
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}, I_D=30\text{A}$		9.8	11.5	$\text{m}\Omega$
			$T_J=125^\circ\text{C}$		16.0	
g_{FS}	Transconductance	$V_{\text{DS}}=5\text{V}, I_D=80\text{A}$		90		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{\text{GS}}=0\text{V}$		0.7	1	V
I_S	Maximum Body-Diode Continuous Current ^G				80	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=30\text{V}, f=1\text{MHz}$		4700		pF
C_{oss}	Output Capacitance			400		pF
C_{rss}	Reverse Transfer Capacitance			180		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1\text{MHz}$		3		Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_D=30\text{A}$		114		nC
Q_{gs}	Gate Source Charge			33		nC
Q_{gd}	Gate Drain Charge			18		nC
$t_{\text{D}(\text{on})}$	Turn-On Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, R_L=1\Omega, R_{\text{GEN}}=3\Omega$		21		ns
t_r	Turn-On Rise Time			39		ns
$t_{\text{D}(\text{off})}$	Turn-Off Delay Time			70		ns
t_f	Turn-Off Fall Time			24		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=30\text{A}, dI/dt=100\text{A}/\mu\text{s}$		53		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=30\text{A}, dI/dt=100\text{A}/\mu\text{s}$		143		nC

A: The value of R_{JJA} is measured with the device in a still air environment with $T_A=25^\circ\text{C}$.

B. The power dissipation P_D is based on $T_{\text{J}(\text{MAX})}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C: Repetitive rating, pulse width limited by junction temperature $T_{\text{J}(\text{MAX})}=175^\circ\text{C}$.

D. The R_{JJA} is the sum of the thermal impedance from junction to case R_{JJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\ \mu\text{s}$ pulses, duty cycle 0.5% max.

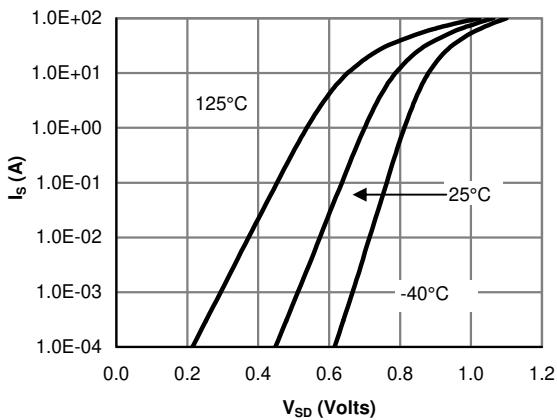
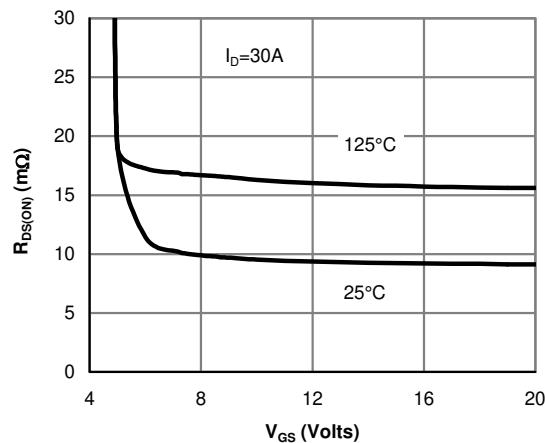
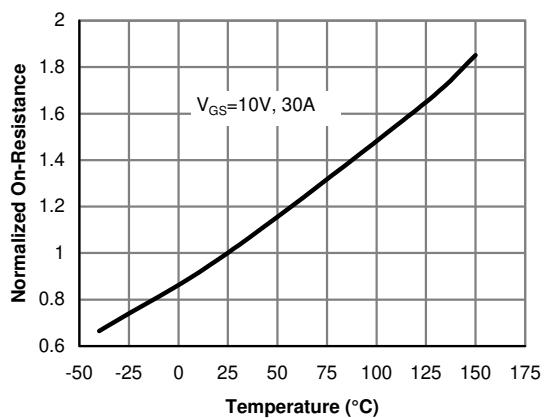
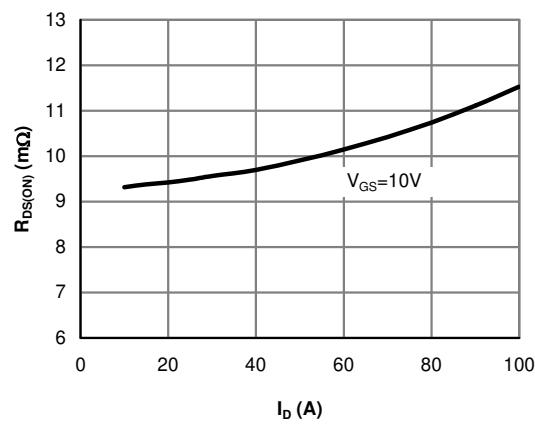
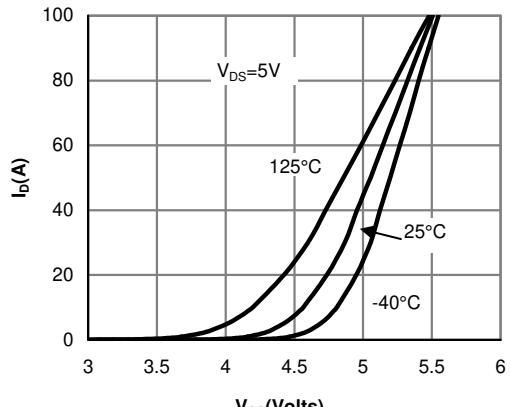
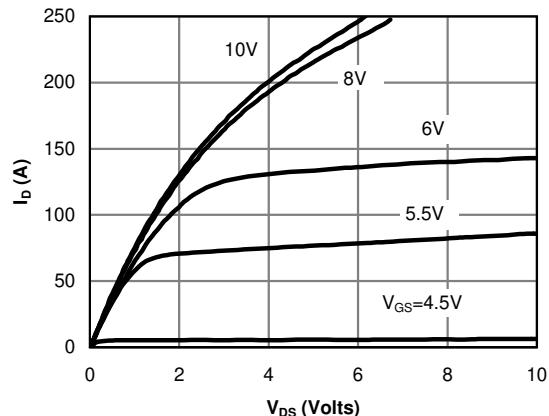
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{\text{J}(\text{MAX})}=175^\circ\text{C}$.

G. The maximum current rating is limited by bond-wires.

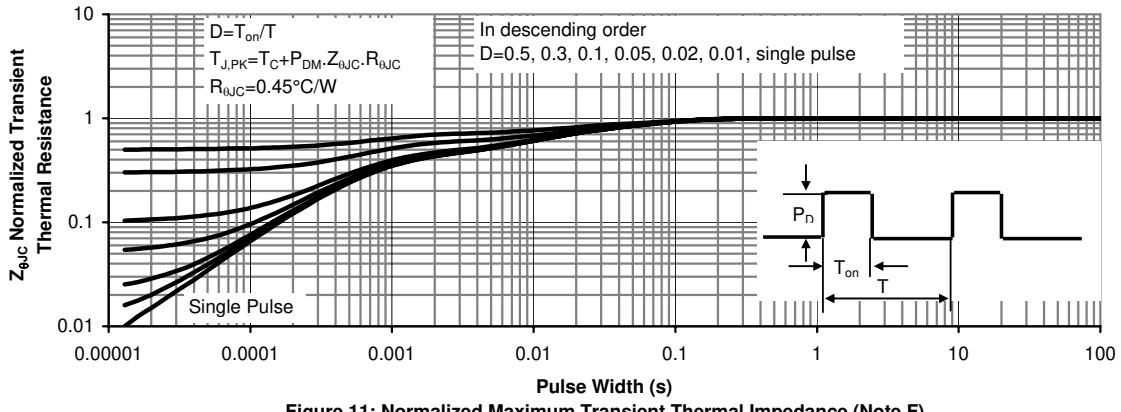
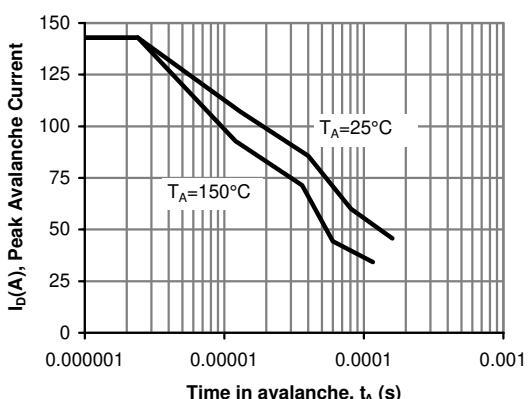
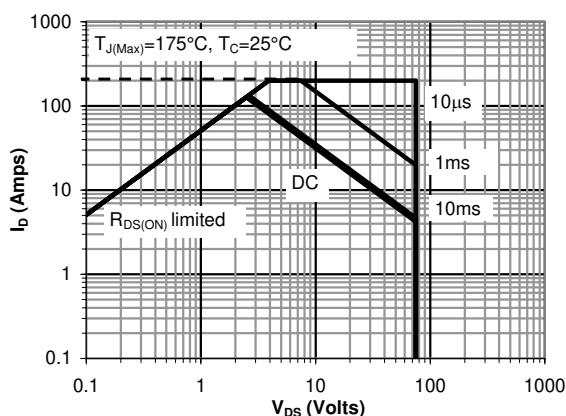
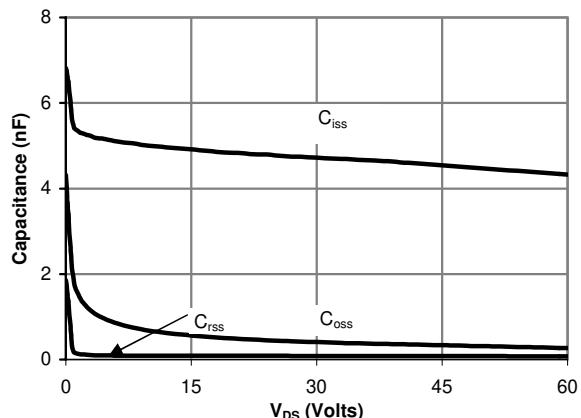
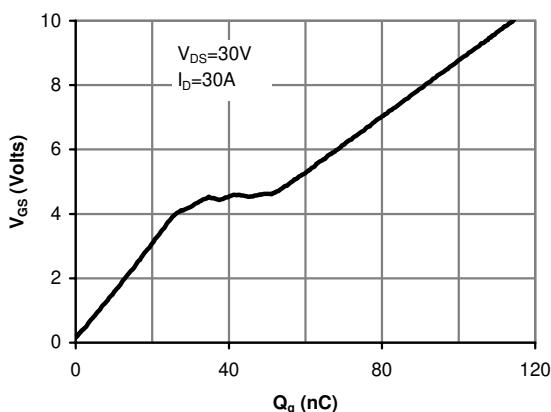
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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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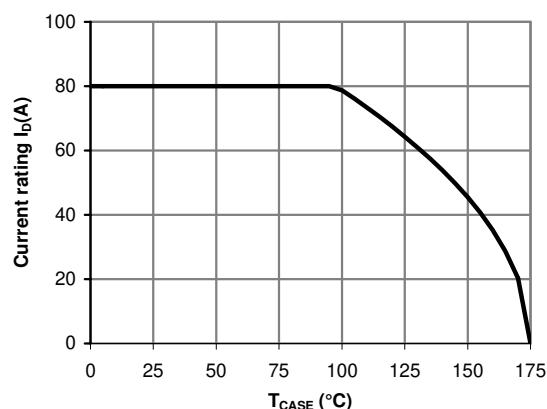


Figure 12: Current De-rating (Note B)

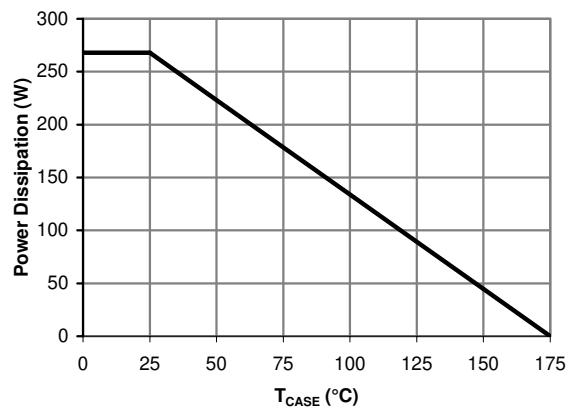


Figure 13: Power De-rating (Note B)